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PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2620053

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHOWA DENKO K.K.	09/30/2013

RECEIVING PARTY DATA

Name:	AJI CO., LTD.	
Street Address:	2-1, SHINKOU 2-CHOME, NAKA-KU	
City:	YOKOHAMA-SHI, KANAGAWA	
State/Country:	JAPAN	
Postal Code:	231-0001	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13131961

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	Q124021
NAME OF SUBMITTER:	MICHELLE L DELOZIER FOR ABRAHAM J ROSNER
Signature:	/Michelle L Delozier/
Date:	11/19/2013

Total Attachments: 1

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PATENT REEL: 031630 FRAME: 0253 CH \$40,00 13131961

Assignment

Whereas, SHOWA DENKO K.K. of 13-9, Shiba Daimon 1-Chome, Minato-Ku, Tokyo 105-8518 JAPAN, hereinafter called Assignor, together with AJI CO., LTD., of 2-1, Shinkou 2-Chome, Naka-Ku, Yokohama-Shi, Kanagawa 231-0001, JAPAN, hereinafter called Assignee, presently and jointly own all right, title and interest in U.S. Patent Application No. 13/131,961 filed May 31, 2011 entitled METHOD OF MOLDING, hereinafter called the '961 application, by virtue of an Assignment from inventors Shigeru YAMAKI, Hideo MIYATA, Nobuyuki MITARAI, Nobuaki ISHII, Katsumi MUROFUSHI and Kunio YOSHIDA executed on April 28, 2011, April 27, 2011, May 10, 2011, April 27, 2011, May 20, 2011 and April 28, 2011, respectively, and recorded in the U.S. Patent and Trademark Office on June 1, 2011 at Reel 026369, Frame 0566; and

Whereas AJI CO., LTD., desires to acquire SHOWA DENKO K.K.'s entire right, title, and interest in the '961 application and invention disclosed therein, and SHOWA DENKO K.K. is willing to assign its interest therein to AJI CO., LTD.;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged:

SHOWA DENKO K.K., hereby sells, assigns and transfers to AJI CO., LTD., its successors and assigns, its entire right, title and interest in the '961 application and the invention disclosed therein for the United States of America, in and to, all Letters Patent to be obtained for said invention by the '961 application, or any continuation, division, renewal, or substitute thereof, and as to Letters Patent any reissue or reexamination thereof, to be held and enjoyed by AJI CO., LTD., its successors and assigns, as fully and entirely as the same would have been held and enjoyed by SHOWA DENKO K.K. had this assignment and sale not been made; and SHOWA DENKO K.K. will execute without further consideration all papers deemed necessary by AJI CO., LTD. in connected with the '961 application when called upon to do so by AJI CO., LTD.

IN WITNESS WHEREOF, SHOWA DENKO K.K. has executed this Assignment by proper persons duly authorized.

SHOWA DENKO K.K.

Date: September 30, 2013

By: Tetsu MORIKI

Tetsu moriki

Corporate Fellow, General Manager, Legal & Intellectual Property Department SHOWA DENKO K.K.

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)

PATENT REEL: 031630 FRAME: 0254

RECORDED: 11/19/2013